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Features

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- 1.2 V to 4.0 V Input Voltage Operating Range
- Typical R_{ON}: 75 mΩ at V_{IN}=3.3 V
 110 mΩ at V_{IN}=1.8 V
 240 mΩ at V_{IN}=1.2 V
- Slew Rate Control with t_R: 110 µs
- Output Discharge Function on FPF1206
- Low <1.5 µA Quiescent Current</p>
- Extra Low <100 nA Off Supply Current</p>
- ESD Protected: Above 7000 V HBM, 2000 V CDM
- GPIO/CMOS-Compatible Enable Circuitry
- 4-Bump WLCSP, 0.76 mm x 0.76 mm, 0.4 mm Pitch

Applications

- Mobile Devices and Smart Phones
- Portable Media Devices
- Ultra-Portable / Mobile Computing
- Advanced Notebook, UMPC, MID
- Portable Medical Devices
- GPS and Navigation Equipment

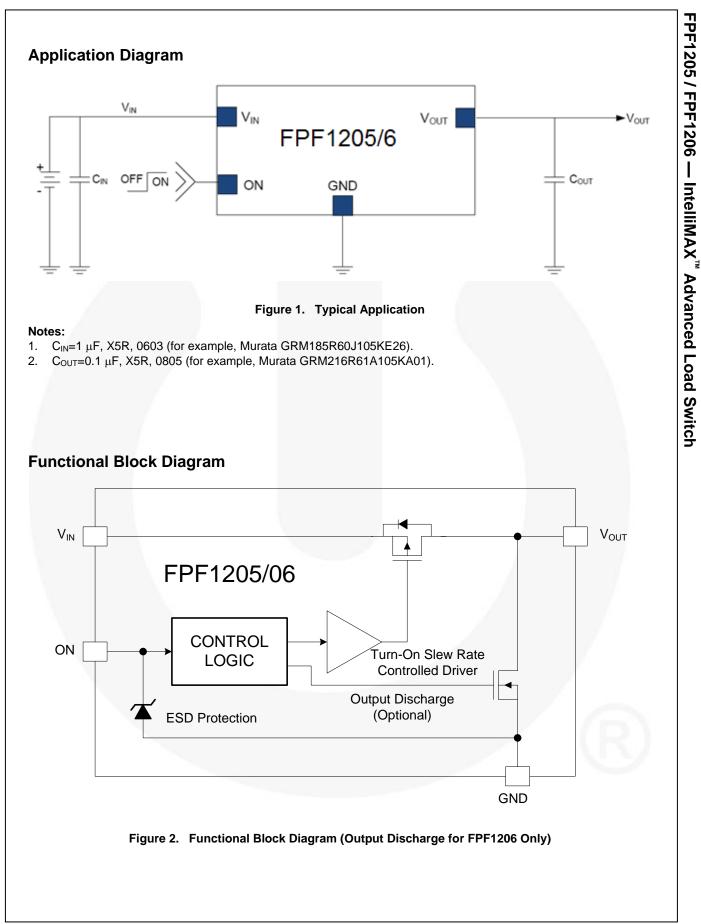
Ordering Information

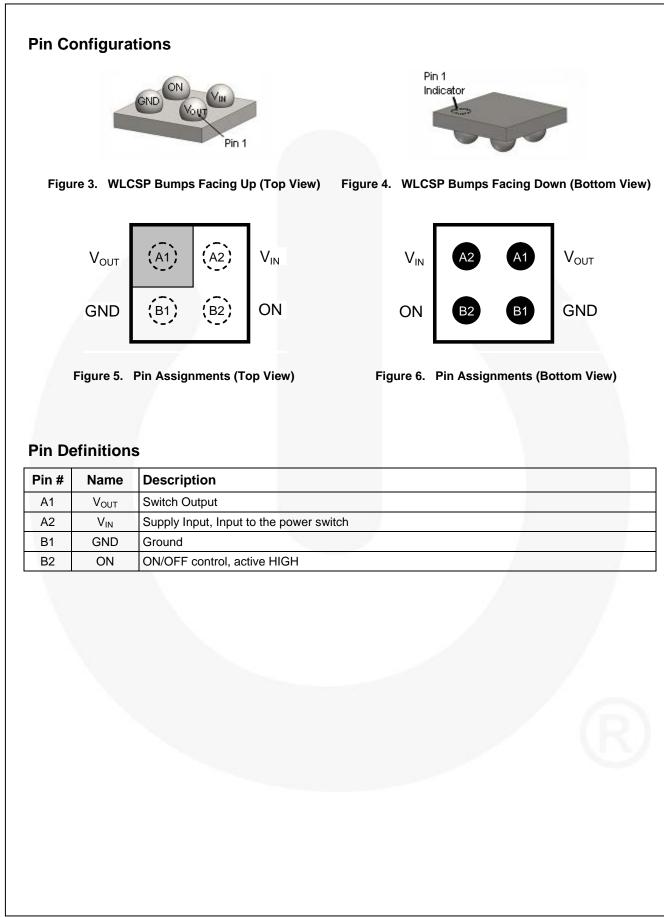
Part Number	Top Marking	Switch (Typical) at 3.3 V _{IN}	Output Discharge	ON Pin Activity	t _R	Package
FPF1205UCX	QJ	75 mΩ	NA	Active HIGH	110 µs	4-Ball WLCSP, 0.76 mm
FPF1206UCX	QK	75 mΩ	6 5Ω	Active HIGH	110 µs	x 0.76 mm, 0.4 mm Pitch

Description

The FPF1205/06 is an ultra-small IntelliMAX[™] load switch with integrated P-channel switch and analog control features. Internal slew-rate control prevents inrush current and the resulting excessive voltage drop on power rail. The input voltage range operates from 1.2 V to 4.0 V to provide power-disconnect capability for post-regulated power rails in portable and consumer products. The low shut-off current of 1 µA (maximum) allows power designs to meet standby and off-power drain specifications.

The FPF1205/06 is controlled by an active-HIGH logic input (ON pin) compatible with standard CMOS GPIO circuitry found on Field Programmable Gate Array (FPGA) and embedded processors. The FPF1205/06 is available in a 0.76 mm x 0.76 mm 4-bump Wafer-Level Chip-Scale Package (WLCSP).





FPF1205 / FPF1206 — IntelliMAXTM Advanced Load Switch

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter			Max.	Unit	
V _{IN}	V _{IN} , V _{OUT} , V _{ON} to GND		-0.3	4.2	V	
I _{SW}	Maximum Continuous Switch Current			1.2	А	
PD	Power Dissipation at T _A =25°C			1.0	W	
T _{STG}	Storage Junction Temperature			+150	°C	
T _A	Operating Temperature Range			+85	°C	
0	Thermal Desistance, lunction to Ambient	1S2P with One Thermal Via		110	°C/W	
Θ_{JA}	Thermal Resistance, Junction-to-Ambient 1S2P without Thermal Via			95	-0/00	
FOD	Electrostotic Discharge Canability ^(3,4)	Human Body Model, JESD22-A114	7			
ESD	Electrostatic Discharge Capability ^(3,4)	Charged Device Model, JESD22-C101	2		kV	

Notes:

- 3. Measured using 2S2P JEDEC std. PCB.
- 4. Measured using 2S2P JEDEC PCB COLD PLATE Method.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter		Max.	Unit
VIN	Supply Voltage		4.0	V
T _A	Ambient Operating Temperature	-40	+85	°C

FPF1205 / FPF1206 — IntelliMAX[™] Advanced Load Switch

Electrical Characteristics

Unless otherwise noted, V_{IN} =1.2 to 4.0 V and T_A =-40 to +85°C. Typical values are at V_{IN} =3.3 V and T_A =25°C.

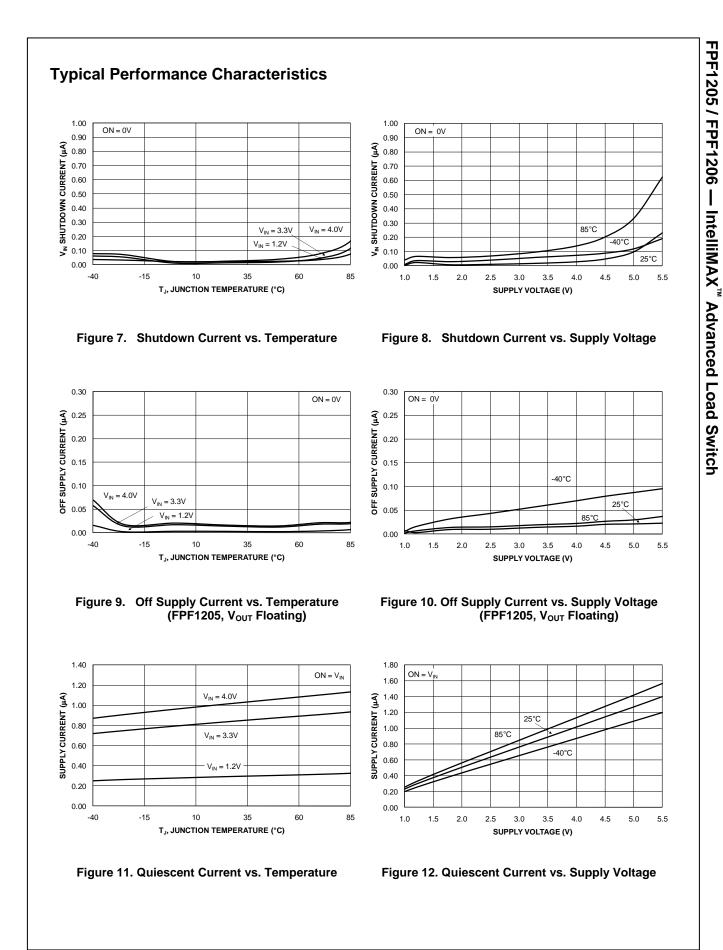
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
Basic Ope	ration			1			
V _{IN}	Supply Voltage		1.2		4.0	V	
I _{Q(OFF)}	Off Supply Current	V _{ON} =GND, V _{OUT} =Open, V _{IN} =4 V			100	nA	
I _{SD}	Shutdown Current	V _{ON} =GND, V _{OUT} =GND			1	μA	
Ι _Q	Quiescent Current	I _{OUT} =0 mA			1.5	μA	
		V _{IN} =3.3 V, I _{OUT} =200 mA, T _A =25°C		75	100	mΩ	
P	On Desistance	V _{IN} =1.8 V, I _{OUT} =200 mA, T _A =25°C		110	150		
R _{ON}	On Resistance	V _{IN} =1.2 V, I _{OUT} =200 mA, T _A =25°C	1	240	300		
		V _{IN} =1.8 V, I _{OUT} =200 mA, T _A =85°C		160	200		
R _{PD}	Output Discharge R _{PULL DOWN}	V _{IN} =3.3 V, V _{ON} =0 V, I _{FORCE} =20 mA, T _A =25°C, FPF1206		65	110	Ω	
V _{IH}	On Input Logic HIGH Voltage	V _{IN} <1.5 V	0.9	0.9			
		V _{IN} =1.5 V to 4.0 V	1.1			- V	
VIL	On Input Logic LOW Voltage	V _{IN} =1.2 V to 4.0 V			0.75	V	
I _{ON}	On Input Leakage	V _{ON} =V _{IN} or GND			1	μA	
Dynamic C	haracteristics ⁽⁵⁾	· · · · · · · · · · · · · · · · · · ·					
t _{DON}	Turn-On Delay ⁽⁶⁾			110			
t _R	V _{OUT} Rise Time ⁽⁶⁾	V _{IN} =3.3 V, R _L =10 Ω, C _L =0.1 μF, T _A =25°C		110		μs	
t _{ON}	Turn-On Time ⁽⁶⁾	T _A =23 C		220			
t _{DOFF}	Turn-Off Delay ⁽⁶⁾			7			
t _F	V _{OUT} Fall Time ⁽⁶⁾	V _{IN} =3.3 V, R _L =10 Ω, C _L =0.1 μF, T _A =25°C, FPF1205		2		μs	
t _{OFF}	Turn-Off Time ⁽⁶⁾	TA-20 0, TTT 1200		9			
t _{DOFF}	Turn-Off Delay			10			
t _F	V _{OUT} Fall Time	V _{IN} =3.3 V, R _L =500 Ω, C _L =0.1 μF, T _A =25°C, FPF1205		95		μs	
t _{OFF}	Turn-Off Time ⁽⁶⁾		- 1	105			
t _{DOFF}	Turn-Off Delay			7.0			
t⊧	V _{OUT} Fall Time	V _{IN} =3.3 V, R _L =500 Ω, C _L =0.1 μF, T _A =25°C, FPF1206 ⁽⁷⁾	1	10.5		μs	
t _{OFF}	Turn-Off Time ⁽⁶⁾			17.5		1	

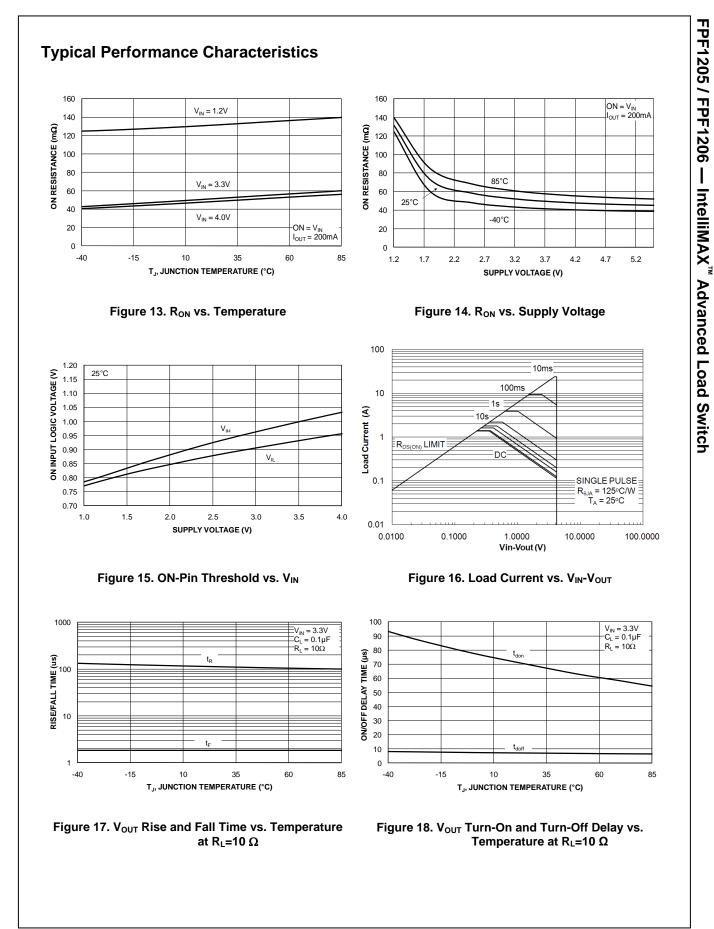
Notes:

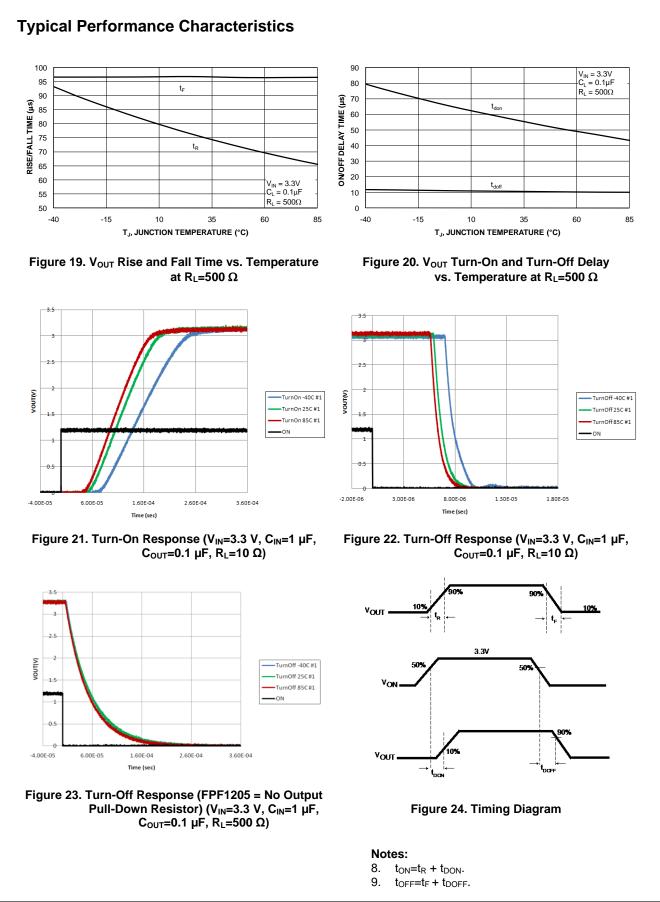
5. These parameters are guaranteed by design and characterization; not production tested.

6. $t_{DON}/t_{DOFF}/t_R/t_F$ are defined in Figure 24.

7. Output discharge path is enabled during device off.







Operation and Application Description

The FPF1205 and FPF1206 are low- R_{ON} P-channel load switches with controlled turn-on. The core of each device is a 50 m Ω P-channel MOSFET and controller capable of functioning over a wide input operating range of 1.2 - 4.0 V. The ON pin, an active HIGH GIOP / CMOS-compatible input, controls the state of the switch.

The FPF1206 contains a 65 Ω on-chip load resistor for quick output discharge when the switch is turned off.

Input Capacitor

To limit the voltage drop on the input supply caused by transient inrush current when the switch turns on into a discharged load capacitor or short-circuit, a capacitor must be placed between the V_{IN} and GND pins. A 1 μ F ceramic capacitor, C_{IN}, placed close to the pins is usually sufficient. Higher-value C_{IN} can be used to reduce the voltage drop in higher-current applications.

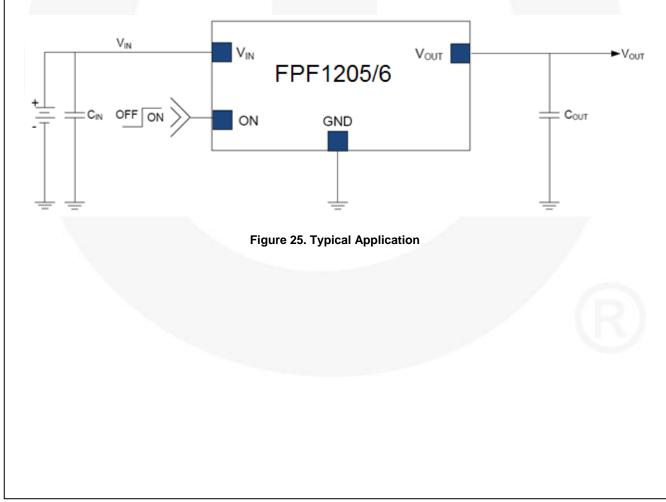
Output Capacitor

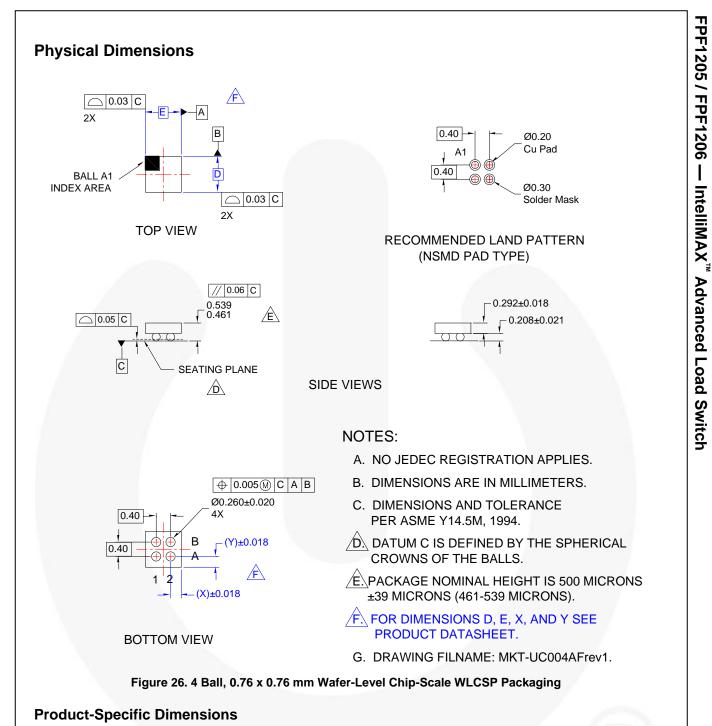
A 0.1 μF capacitor, $C_{OUT},$ should be placed between the V_{OUT} and GND pins. This capacitor prevents parasitic

board inductance from forcing V_{OUT} below GND when the switch is on. C_{IN} greater than C_{OUT} is highly recommended. C_{OUT} greater than C_{IN} can cause V_{OUT} to exceed V_{IN} when the system supply is removed. This could result in current flow through the body diode from V_{OUT} to V_{IN}.

Board Layout

For best performance, all traces should be as short as possible. To be most effective, the input and output capacitors should be placed close to the device to minimize the effect that parasitic trace inductance may have on normal and short-circuit operation. Using wide traces or large copper planes for all pins (V_{IN} , V_{OUT} , ON, and GND) helps minimize the parasitic electrical effects along with minimizing the case ambient thermal impedance. However, the V_{OUT} pin of FPF1206 should not connect directly the battery source due to the discharge mechanism of the load switch.





Product	D	E	X	Y
FPF1205UCX	760 μm ±30 μm	760 μm ±30 μm	0.180 mm ±0.018 µm	0.180 mm ±0.018 µm
FPF1206UCX	760 μm ±30 μm	760 μm ±30 μm	0.180 mm ±0.018 μm	0.180 mm ±0.018 μm

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